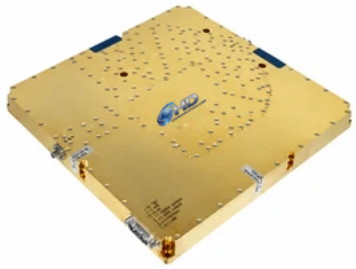
HD31137
SOLID STATE HIGH POWER AMPLIFIER

FEATURES

Class AB linear GaN design
Instantaneous wide bandwidth
Suitable for all single channel modulation standards
Built-in protection circuits
High reliability and ruggedness



ELECTRICAL SPECIFICATIONS

Parameter	Specification	Notes
Operating Frequency Range	2.0 - 18.0 GHz	
Power Output @ Psat	30 Watt Min	CW
Power Output @ P1dB GCP	>15 Watt Typ	
Power Gain	45 dB Min	
Power Gain Flatness	<14 dB p-p Typ	Constant input power
Input Return Loss	-10 dB Max	Relative to 50 Ohm
Harmonics	-30 dBc Typ	At rated Pout
Spurious	-60 dBc Max	Non-harmonics
Operating Voltage	32 VDC Nom	
Current Consumption	18 Amp Max / 13 Amp Typ	At rated Pout
Input Power Protection	+2 dBm Max	<10 Sec without damage
Load VSWR Protection	5 : 1 Max	<1 minute at rated Pout

ENVIRONMENTAL CHARACTERISTICS

Parameter	Specification	Notes
Operating Case Temperature	-20 to +65 °C	
Storage Temperature	-40 to +85 °C	
Relative Humidity	5 to 95 %	Non-condensing

MECHANICAL SPECIFICATIONS

Parameter	Specification	Notes
Dimensions	260 x 260 x 27 mm	Excluding connectors
Weight	4 Kg.	
RF Connectors In/Out	Hi-Freq. SMA female	
DC Power / Interface Connector	9-Pin D-Sub	
Cooling	External Heatsink	Forced air required

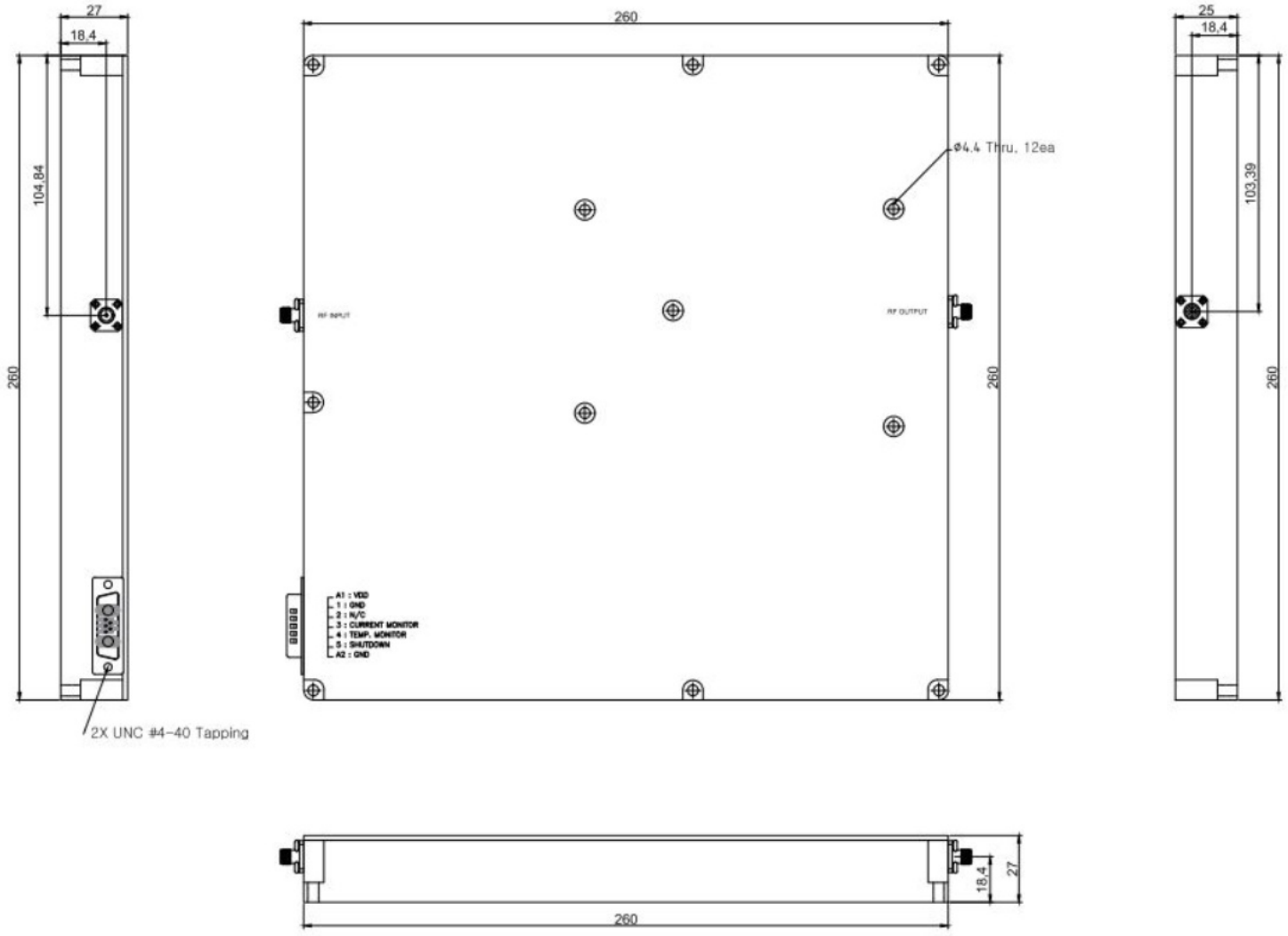
D-SUB CONNECTOR PIN ASSIGNMENT

Pin	Function	Description
1	N/A	N/A
2	N/A	N/A
3	CURRENT SENSOR	I_D@20mV/100mA Typ
4	TEMP SENSOR	V_T@10mV/°C + 500mV Typ
5	SHUTDOWN	Enable = TTL "High" (>3.2V) or Open / Disable = TTL "Low" or Short
6, 7	VDD	32VDC
8, 9	GND	Ground

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Specifications subject to change without notice. Specifications and drawings may vary with selected options.

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OUTLINE DRAWING



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